

Title (en)

Assembly method, temperature sensing system and steam iron

Title (de)

Montageverfahren, Temperaturfühlersystem und Dampfbügeleisen

Title (fr)

Procédé de montage, système de sonde de température et fer à repasser à vapeur

Publication

EP 2799614 A3 20141126 (DE)

Application

EP 14166126 A 20140428

Priority

- ES 201330633 A 20130430
- ES 201330632 A 20130430

IPC 8 full level

D06F 75/00 (2006.01); **D06F 75/26** (2006.01)

CPC (source: EP)

D06F 75/00 (2013.01); **D06F 75/26** (2013.01)

Citation (search report)

- [AD] US 6172335 B1 20010109 - GOODRICH GARY [US]
- [A] US 5448038 A 19950905 - KIM DAE-RAE [KR]
- [A] JP H07263133 A 19951013 - TOSHIBA CORP
- [A] US 5201797 A 19930413 - WENG SHUN-TE [TW]

Designated contracting state (EPC)

AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)

BA ME

DOCDB simple family (publication)

EP 2799615 A1 20141105; EP 2799615 B1 20160608; EP 2799614 A2 20141105; EP 2799614 A3 20141126; EP 2799614 B1 20160427

DOCDB simple family (application)

EP 14166137 A 20140428; EP 14166126 A 20140428